

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

ltc3110huf#pbf

(Engineering Calculation)

QFN 4mm X 4mm Exp. Pad

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**TOTAL MASS (g) : 0.042322**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.002955	1000000	69822.65625		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.015961	975000	377136.875		
		Iron (Fe)	7439-89-6	0.000393	24000	9286.05859375		
		Phosphorus (P)	7723-14-0	0.000005	300	118.143241882		
		Zinc (Zn)	7440-66-6	0.000011	700	259.915130615		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.016370</b>	<b>1000000</b>	<b>386800.96875</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000773	1000000	18253.3007812		
		<b>External Plating Total:</b>				<b>0.000773</b>	<b>1000000</b>	<b>18253.3007812</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000362	1000000	8553.5703125		
		<b>Internal Plating Total:</b>				<b>0.000362</b>	<b>1000000</b>	<b>8553.5703125</b>
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001186	750000	28023.5761719		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000395	250000	9333.31640625		
<b>Die Attach Total:</b>				<b>0.001581</b>	<b>1000000</b>	<b>37356.8945312</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.002616	130000	61812.5429688		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.017303	860000	408846.5		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000201	10000	4749.35839844		
		<b>Encapsulation Total:</b>				<b>0.020120</b>	<b>1000000</b>	<b>475408.40625</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000161	1000000	3804.21240234		
					<b>TOTAL MASS (g) :</b>	<b>0.042322</b>		